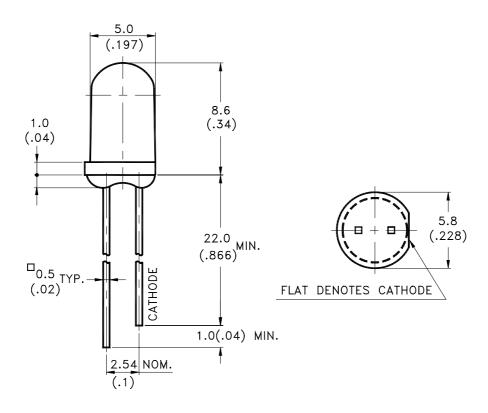


Property of Lite-On Only

#### **Features**

- \* High luminous intensity output.
- \* Low power consumption.
- \* High efficiency.
- \* Versatile mounting on P.C. board or panel.
- \* I.C. Compatible/low current requirements.
- \* Popular T-13/4 diameter.

#### **Package Dimensions**



Part No.	Lens	Source Color
LTL2V3UEJWL0008	White Diffused	AlInGaP Red

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25$ mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

Part No.: LTL2V3UEJWL0008 Page: 1 of 9



# LITEON LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

# Absolute Maximum Ratings at TA=25℃

Parameter	Maximum Rating	Unit	
Power Dissipation	120	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	130	mA	
DC Forward Current	50	mA	
Derating Linear From 40°C	0.75	mA/°C	
Reverse Voltage	5	V	
Operating Temperature Range	-40°C to + 80°C		
Storage Temperature Range	-55°C to + 100°C		
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds		

Page: 2 Part No.: LTL2V3UEJWL0008 of



Property of Lite-On Only

#### Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Radiant Intensity	Ie	4.9		8.5	mW/sr	$I_F = 20 \text{mA}$
Viewing Angle	201/2		30		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λР		632		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd		624		nm	Note 4
Spectral Line Half-Width	Δλ		20		nm	
Forward Voltage	VF		2.0	2.4	V	$I_F = 20 \text{mA}$
Reverse Current	IR			100	μΑ	$V_R = 5V$
Capacitance	С		40		pF	$V_F = 0$ , $f = 1MHz$
Centering ( X / Y )		-0.12		+0.12	mm	

#### NOTE:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Radiometric Intensity (mW/sr at 20mA)

Bin	Min.	Max.
G	4.9	5.9
Н	5.9	7.1
J	7.1	8.5

Note: Tolerance for each bin will be  $\pm$  15%

Part No.: LTL2V3UEJWL0008 Page: 3 of 9

Property of Lite-On Only

#### Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

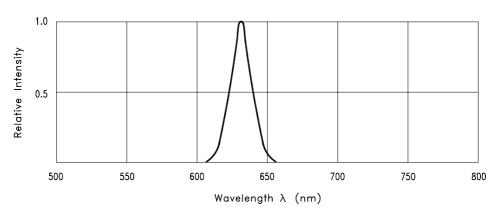
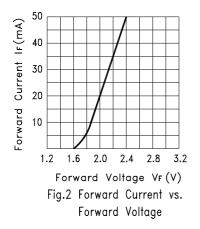
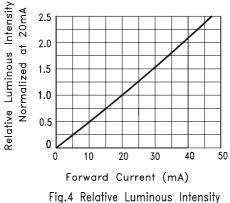
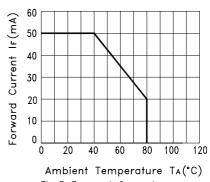


Fig.1 Relative Intensity vs. Wavelength





vs. Forward Current



Ambient Temperature Ta(°C)
Fig.3 Forward Current
Derating Curve

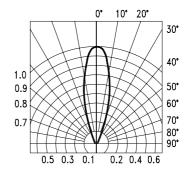


Fig.5 Spatial Distribution

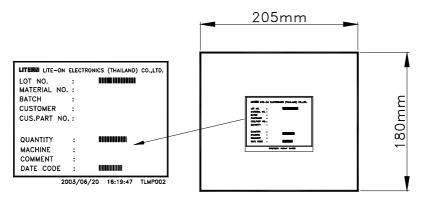
Part No.: LTL2V3UEJWL0008 Page: 4 of 9



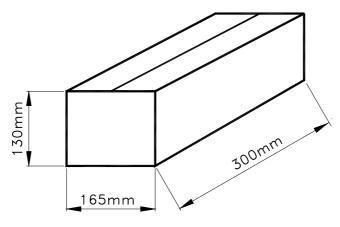
Property of Lite-On Only

# Packing Spec

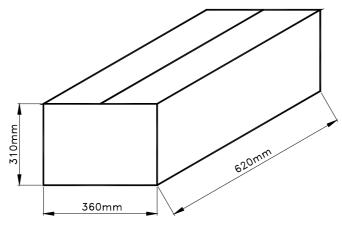
1000, 500 or 250 pcs per packing bag



8 packing bags per inner carton total 8000 pcs per inner carton



8 Inner cartons per outer carton total 64000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing



Part No.: LTL2V3UEJWL0008 Page: 5 of 9



Property of Lite-On Only

#### **CAUTIONS**

#### 1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

#### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

#### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

#### 4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

#### 5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering iron		Wave soldering		
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

Part No.: LTL2V3UEJWL0008 Page: 6 of 9

Property of Lite-On Only

#### 6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

# Circuit model A Circuit model B LED LED LED

- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

#### 7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

Part No.: LTL2V3UEJWL0008 Page: 7 of 9



Property of Lite-On Only

#### Suggested checking list:

#### Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

#### Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

#### Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: \*50V for Blue LED.

#### **Device Handling**

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

#### Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Part No.: LTL2V3UEJWL0008 Page: 8 of 9



# LITEON LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

## 8. Reliability Test

Classification	ssification Test Item Test Condition		Reference Standard		
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)		
	High Temperature High Humidity Storage	Ta= $65\pm5^{\circ}$ C RH= $90 \sim 95\%$ Test Time= $240$ HRS $\pm2$ HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)		
Endurance Test	High Temperature High Humidity Reverse BIAS	Ta= $65\pm5^{\circ}$ C RH= $90 \sim 95\%$ VR=5V Test Time = $500$ HRS (- $24$ HRS, $+48$ HRS)	JIS C 7021 : B-11(1982)		
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)		
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)		
Environmental Test	Temperature Cycling	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)		
	Thermal Shock	$105 \pm 5^{\circ}$ C $\sim -55^{\circ}$ C $\pm 5^{\circ}$ C $10$ mins $10$ Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)		
	Solder Resistance	T.sol = $260 \pm 5$ °C Dwell Time= $10 \pm 1$ secs	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)		
	Solderability	T. sol = $230 \pm 5^{\circ}$ C Dwell Time= $5 \pm 1$ secs	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)		

#### 9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

Part No.: LTL2V3UEJWL0008	Page :	9	of	9	